UP2UC

UNI-PAC™ drum core power inductors



Product features

- 12.7 mm x 9.5 mm x 5.21 mm drum core
- Inductance range from 1.0 μH to 1000 μH
- Current range from 0.30 A to 9.0 A
- · Ferrite core material

Applications

- Desktop computer
- Workstations/servers
- DVD Players
- Portable power devices
- Base stations
- Industrial power supplies
- Output filter chokes
- Test equipment instrumentation
- · Buck or boost inductor

Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
 J-STD-020 (latest revision) compliant









Product specifications

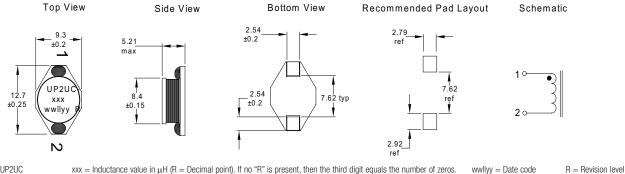
	OCL1	I _{rms²}	I _{sat³}	SRF MHz	DCR mΩ@ +20 °C	DCR mΩ@ +20 °C	
Part Number⁵	μH ± 20%	(A)	(A) @ +25 °C	Typical	Typical	Maximum	K-factor⁴
UP2UC-1R0-R	1.0	6.8	9.0	100	4.0	9.0	216
UP2UC-1R5-R	1.5	6.4	8.0	90.0	4.4	10.0	177
UP2UC-2R2-R	2.2	6.1	7.0	80.0	5.8	12.0	130
UP2UC-3R3-R	3.3	5.4	6.4	65.0	9.9	15.0	114
UP2UC-4R7-R	4.7	4.8	5.4	45.0	12.0	18.0	92.52
UP2UC-6R8-R	6.8	4.4	4.6	38.0	25.8	27.0	77.72
UP2UC-100-R	10.0	3.9	3.8	30.0	25.9	38.0	62.68
UP2UC-150-R	15.0	3.1	3.0	27.0	35.4	46.0	49.82
UP2UC-220-R	22.0	2.7	2.6	19.0	55.9	85.0	41.34
UP2UC-330-R	33.0	2.1	2.0	15.0	81.6	100	34.09
UP2UC-470-R	47.0	1.8	1.6	12.0	120	140	29.00
UP2UC-680-R	68.0	1.5	1.4	10.0	145	200	24.59
UP2UC-101-R	100	1.3	1.2	9.0	211	280	20.89
UP2UC-151-R	150	1.0	1.0	6.0	347	400	15.80
UP2UC-221-R	220	0.80	0.80	5.0	491	610	13.04
UP2UC-331-R	330	0.60	0.60	4.5	750	1020	10.85
UP2UC-471-R	470	0.50	0.50	3.5	1188	1270	9.39
UP2UC-681-R	680	0.40	0.40	2.5	1811	2020	7.56
UP2UC-102-R	1000	0.30	0.30	2.0	2757	3000	6.13

- 1 Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.25 V_{rms} , 0.0 Adc 2 I_{rms} : DC current for an approximate ΔT rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed $+125\ ^{\circ}\text{C}$ under worst case operating conditions verified in the end application.
- 3 I_{Sat} : Peak current for approximately 7.5% rolloff at +25 °C.

- 4 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K \star L \star \Delta I$, B_{p-p} : (Gauss),
- K: (K-factor from table), L: (inductance in μH), ΔI (peak-to-peak ripple current in amps).

 6 Part Number Definition: UP2CU-xxx-R
- UP2CU = Product code and size
- \bullet xxx= Inductance value in $\mu\text{H},\,\text{R}=$ decimal point. If no R is present, then third digit equals the number of zeros.
- "-R" suffix = RoHS compliant

Dimensions-mm



Part Marking: UP2UC

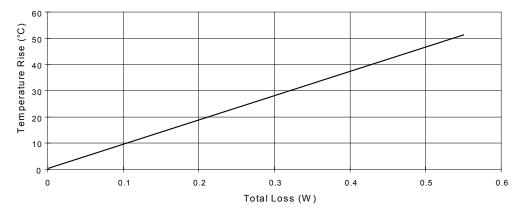
xxx =Inductance value in μH (R = Decimal point). If no "R" is present, then the third digit equals the number of zeros. wwllyy = Date code

Tolerances are ±0.254 mm unless otherwise specified. Do not route traces or vias underneath the inductor

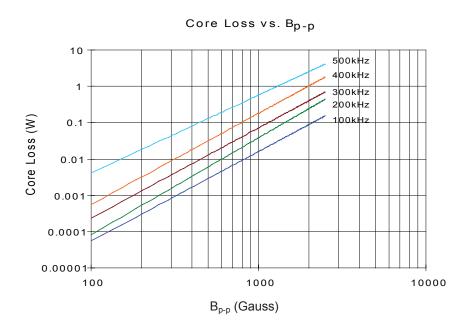
Packaging information-mm

1.5 dia. -1.75 Supplied in tape-and-reel packaging, 600 parts per reel, 13" diameter reel. 24 ±0.30 4.40 9.70 Section A-A User direction of feed

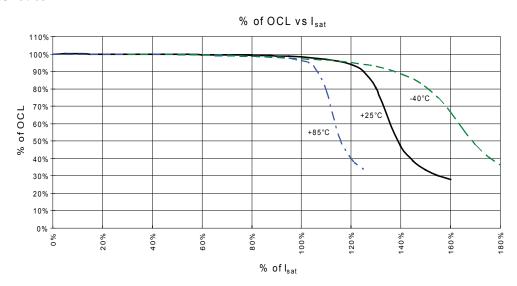
Temperature rise vs total loss



Core loss vs Bp-p



Inductance characteristics



Solder Reflow Profile

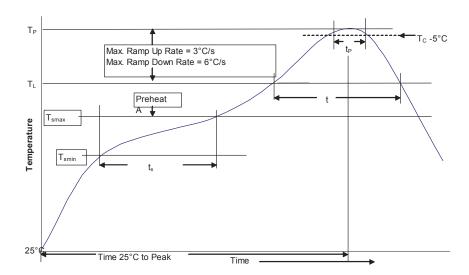


Table 1 - Standard SnPb Solder (T_c)

	Volume	Volume
Package	mm³	mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

	Volume	Volume	Volume
Package	mm³	mm³	mm³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body	temperature (T _P)*	Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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